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ŀ	Name of conveying party(less	Name and address of receiving party(ies):	
-	The state of the s	ranic and address of receiving party(ies).	
- [Akira Ogino and Nozomu Ikeda		
		Name: Sony Corporation Internal Address:	
-	Additional name(s) of conveying party(ies) attached? Yes No	Internal Address.	
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J	3. Nature of Conveyance:]	
۱	(a)	Street Address: 7-35 Kitashinagawa 6-chome Shinagawa-ku, Tokyo, Japan	
d	X Assignment	Jimagawa-ku, Tokyo, Japan	
J		City State ZIP	
٦	Security Agreement Change of Name		
V			
Ĭ	Other	Additional name(s) & address(es) attached? Yes X No	
٦	Execution Date: April 02, 1998		
╁	4. Application number(s) or patent number(s):		
1	repproaction number(s) or patent number(s).		
1	If this document is being filed together with a new application, the execution da	ate of the application is:	
V	A. Patent Application No.(s)	B. Patent No.(s)	
1	08/974,624		
٦			
	4199	Yes X No	
٦	Additional numbers attached?	Li Yes Lai No	
١	 Name and address of party to whom correspondence concerning document should be mailed: 	6. Total number of applications and patents involved:	
ĺ	constraint december stout of manage		
ı	Nome: Joy U Majali		
	Name: Jay H. Maioli	7. Total fee (37 CFR 3.41):\$ 40.00	
1	Internal Address: Cooper & Dunham LLP		
		X Enclosed	
l			
	ŀ	Authorized to be charged to deposit account	
١	Street Address: 1185 Avenue of the Americas	8. Deposit account number:	
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. [.	Name of Person Signing Signature	Date	
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	regarding this burden estimate to the U.S. Patent and Trademark Office D.C. 20231, and to the office of Management and Budget, Paperwork	e, Office of Information Systems, PK2-1000C, Washington,	

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in <u>VIDEO SIGNAL TRANSMISSION METHOD</u>, <u>SUPERIMPOSED INFORMATION EXTRACTION METHODM</u>, <u>VIDEO SIGNAL OUTPUT DEVICE</u>, <u>VIDEO SIGNAL RECORDING DEVICE AND VIDEO SIGNAL RECORDING MEDIUM</u> for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at6-7-35 Kitashinagawa, Shinagawa-Ku, Tokyo, Japan (hereinafter reference as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereof;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereof;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number_08/974,624___, Filing Date_November 19, 1997

This assignment executed on the dates indicated below.

Akira Oqino	April 2, 1998
Name of first or sole inventor	Execution date of U.S. Patent Application
Chiba, Japan	
Residence of first or sole inventor	4
Axiva Ogino	April 2, 1998
Signature of first or sole inventor	Date of this assignment
	PATENT

REEL: 9107 FRAME: 0749

Nozomu Ikeda	april . 2. 1998		
Name of second inventor	Execution date of U.S. Patent Application		
Tokyo, Japan			
Residence of second inventor	0 (1		
Signature of second inventor	april 2. 1998		
Signature of second inventor	Date of this assignment		

PATENT REEL: 9107 FRAME: 0750